

C0805X392K2RACTU

Aliases (C0805X392K2RAC7800) SMD Comm X7R Flex, Ceramic, 3,900 pF, 10%, 200 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 0805, 0.6 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X7R Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Temperature Stable
Features	FT-CAP, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	13 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	3,900 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

 Dimensions

 Chip Size
 0805

 L
 2mm +/-0.3mm

 W
 1.25mm +/-0.3mm

 T
 0.78mm +/-0.20mm

 S
 0.6mm MIN

 B
 0.5mm +/-0.25mm

Packaging Specifications Packaging

PackagingT&R, 180mm, Plastic TapePackaging Quantity4000

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